Manifestation of chiral tunneling at a tilted graphene *p*-*n* junction

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Electrons in graphene follow unconventional trajectories at p-n junctions, driven by their pseudospintronic degree of freedom. The prominent angular dependence of transmission is significant, capturing the chiral nature of the electrons and culminating in unit transmission at normal incidence (Klein tunneling). We theoretically show that such chiral tunneling can be directly observed from the junction resistance of a tilted interface probed with separate split gates. The junction resistance is shown to increase with tilt, in agreement with recent experimental evidence. The tilt dependence arises because of the misalignment between modal density and the anisotropic transmission lobe oriented perpendicular to the tilt. A critical determinant is the presence of specular edge scattering events that can completely reverse the angle dependence. The absence of such reversals in the experiments indicates that these edge effects are not overwhelmingly deleterious, making the premise of transport governed by electron "optics" in graphene an exciting possibility.

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I. INTRODUCTION

A striking feature of electron flow in graphene, gated uniformly or electrostatically "doped" into junctions, is the nontrivial dynamics of its pseudospins arising from its orthogonal dimer basis sets. The overall photon-like dispersion propels electrons along trajectories intuitive of Snell's law, conserving quasimomentum components transverse to the interface. However, the corresponding "Fresnel equations" are qualitatively different from their optical counterpart, determined by conservation of pseudospins. In particular, graphene electrons are chiral in nature, meaning the pseudospin components are related to the direction of momentum. This results in perfect transmission at normal incidence,¹ regardless of voltage gradients across the junction (Klein tunneling). For other incident angles, the spinor mismatch leads to a unique angle dependent transmission across the junction. Thus, while conventional electronics in graphene faces possibly steep challenges,² the dynamics of pseudospintronics can usher in novel concepts such as electronic Veselago lens,³ subthermal switches driven by a geometry induced metal-insulator transition,⁴ and Andreev reflections.⁵

Despite the exciting physics of chiral electron flow, its measurable signatures have so far been sparse and indirect. Signatures of Klein tunneling were seen^{6,7} in the preferential transmission of normally incident carriers predicted in Ref. 8. A more direct measurement was the conductance oscillation in an *n*-*p*-*n* structure.⁹ The reflection amplitude undergoes a phase shift of π at normal incidence under the action of a magnetic field, due to the cyclotron bending of the carriers.¹⁰ However, the main underlying physics of the angle dependent electron transmission needs to be explicitly measured. A proper model that can capture both the quantum mismatch of spinors over different doping regimes is lacking, as well as diffusive scattering to explore their robustness to impurity and edge scattering events.

In this paper we focus on a tilted graphene p-n junction (GPNJ) (i) to show that it serves as an explicit signature of chiral tunneling. We show that the junction resistance

(similar to the odd resistance shown in other experiments 6,7) is higher than the nontilted device (Fig. 1). We argue that this enhancement originates from the chiral nature of graphene electrons which manifests itself through the highly angle dependent transmission characteristics of GPNJ (Fig. 2). The angular transmission lobe, oriented perpendicular to the interface, is rotated with the tilt, where fewer transmitting modes exist. Therefore the conductance modulation would not happen for nonchiral, nonrelativistic electrons with isotropic transmission. The results follow closely with our recent transport measurements of a tilted GPNJ in a structure that has separately controlled split-gate voltages.¹¹ (ii) We present an analytical solution to the spinor mismatch problem (Sec. II) as well as a nonequilibrium Green's function (NEGF) based atomistic numerical calculation (Sec. III). An efficient matrix inversion algorithm is employed to reach near experimental dimensions and capture both quantum mechanical and diffusive contributions to the overall resistance. We find that charged impurity scattering dilutes but does not eliminate the modulation in conductance (Figs. 1 and 3) (Sec. IV). (iii) Notably, we demonstrate that specular scattering events at edges can reverse the trend in modulation (Sec. V), giving an interfacial resistance that decreases with tilt (Fig. 4). Such a decrease has been seen in the past,¹² but its physical origin needs to be identified. The absence of such a reversal in experiments surprisingly points to their elimination, possibly through incoherent scattering processes dominant at the strained edges.

II. ANALYTICAL MODEL

The conductance of a GPNJ can be written as $G = G_0 \sum_i^M T(\theta_i)$, where $G_0 = 4q^2/h$ is the conductance quantum including spin and valley degeneracies and $T(\theta_i)$ is the incident angle dependent transmission probability with $\theta_i = \tan^{-1}(k_y/k_x)$. *M* is the number of modes from the incident side for a given Fermi energy E_F relative to its Dirac point and can be approximated as $M \approx W|E_F|/\pi\hbar v_F$ over the linear *E*-*k* regime. The angle dependent transmission *T* is obtained by



FIG. 1. (Color online) (a) False color scanning electron microscopy (SEM) image (Ref. 11) and (b) device schematic. Two split gates, separated by a distance *d*, create a *p*-*n* junction with a linear potential variation across the junction. The gates are placed at an angle δ with respect to the transport direction. (c) Experimental (Ref. 11) and (d) theoretical junction resistance (R_J) vs voltage and energy respectively for $\delta = 0.45^{\circ}$. In (d), we plot R_J vs $E_F = \hbar v_F \sqrt{\pi \alpha_G C_G |V_{G1}|/q}$ from an atomistic calculation for a 100 nm wide graphene sheet.

pseudospin conservation across the junction,⁴

$$T(E_F, \theta_i) = \left\lfloor \frac{\cos \theta_i \cos \theta_r}{\cos^2 \left(\frac{\theta_i + \theta_r}{2}\right)} \right\rfloor e^{-\pi \hbar v_F k_F^2 d \sin^2 \theta_i / V_0}, \quad (1)$$

for incident angles above the critical angle as defined below. Equation (1) is a general form of the transmission expression in Refs. 8 and 13 and works for the entire voltage range from the *p*-*n* to *n*⁺-*n* junction. The incident and refracted angles θ_i and θ_r are related by Snell's law,³ $E_F \sin \theta_i = (E_F - V_0) \sin \theta_r$, with V_0 (Fig. 1) being the voltage barrier across the junction, and $k_F = E_F/\hbar v_F$. The Snell's law arises from transverse quasimomentum (k_y) conservation [the energy band diagram in Fig. 1(b)]. For incident angles above the critical angle, $\theta_C = \sin^{-1} | \frac{E_F - V_0}{E_F} |$, k_y cannot be conserved and *T* becomes zero.

For a tilted junction, the incoming mode angles are modified, so that the conductance becomes

$$G(E_F) = G_0 \sum_{i}^{M(E_F)} T(E_F, \theta_i + \delta), \qquad (2)$$

where δ is the tilt angle as shown in Fig. 1. In Eq. (2) the effective split between the two gates is $d/\cos \delta$. As a result of the angle dependence, the transmission lobe at a particular energy will rotate by the tilt angle [Fig. 2(a)]. The transverse wave vector $k_y = k \sin \theta$ gives $\Delta \theta = \Delta k_y / (k \cos \theta)$, thus the angular spacing between modes [the total number of modes at θ is $N(\theta) = \frac{Wk}{\pi} \sin \theta$] increases at higher angles relative to



FIG. 2. (Color online) (a) Angular transmission for various tilt angles. (b) With tilt, the transmission lobe moves into a low angular mode density ($\sim \cos \theta$) area, giving (c) a gradual decrease in transmission [Eq. (3)] for a symmetric *p*-*n* junction. (d) Junction resistance at 0 K predicted from Eq. (4). We see resonances which become more pronounced as we go into smaller systems.

the *transport axis*, resulting in lower angular mode density, $\frac{dN}{d\theta} = \frac{1}{\Delta\theta}$. A tilt at the junction thus shifts the transmission window onto a high angle region where the mode density is less, decreasing the overall transmission [Fig. 2(c)]. In the limit when the number of modes is very few, the experiment will give the mode resolved angle dependent transmission properties [Fig. 2(a)]. For an abrupt, symmetric *p*-*n* junction, the transmission expression reduces to $\cos^2 \theta$ from Eq. (1) and it is easy to see the impact of tilt,

$$G \approx G_0 \int_{-\pi/2}^{\pi/2-\delta} \frac{T(\theta+\delta)}{\Delta\theta} d\theta = G_0 \left[\frac{2}{3}\cos^4\left(\frac{\delta}{2}\right)\right] M. \quad (3)$$

The factor 2/3 arises from the wave-function mismatch across the junction and the tilt introduces an additional scaling factor, which further reduces conductance. We define average transmission over all modes as $T_{av} = G/(G_0M)$. The gradual decrease of T_{av} with δ in Fig. 2(c) constitutes a direct manifestation of chiral tunneling in graphene.

To connect with experimental measurements, we next analyze the variation of the junction resistance in presence of an intrinsic background doping (V_{DP}) in the graphene sheet [Fig. 2(d)]. We vary the gate voltages so that $V_{G1} = -V_{G2}$ but a nonzero V_{DP} makes it an asymmetric GPNJ. The effective gate voltages on the graphene sheet are $\alpha_G(V_{G1} + V_{DP})$ and $\alpha_G(V_{G2} + V_{DP})$, where α_G is the capacitive gate transfer factor. The junction resistance can be written as¹⁴

$$R_J = \left(\frac{4q^2}{h}\right)^{-1} \left[\frac{1 - T_{\rm av}}{MT_{\rm av}}\right].$$
 (4)

Figure 2(d) plots R_J against $E_F = \hbar v_F \sqrt{(\pi) \alpha_G C_G |V_{G1}|/q}$, the amount of shift in the Dirac point by V_{G1} , for a 100 nm

wide graphene sheet with a split gate separation d = 200 nm. For the voltage range $|V_{G1}| < V_{DP}$, we are in the n^+ -n regime for positive V_{DP} and p^+-p for negative. Under these near homogeneous conditions, the junction resistance predicted by Eqs. (1)–(4) is small, because the pseudospin states match and there is no Wentzel-Kramers-Brillouin (WKB) tunneling term in Eq. (1). When $|V_{G1}| > V_{DP}$, we are in the *p*-*n* junction regime and resistance jumps to a high value, primarily due to the WKB factor in Eq. (1) (a similar trend was seen in Refs. 6 and 7). The rate of change in R_J with V_{G1} is determined by d. For the 45° tilted junction, the junction resistance is higher than the nontilted resistance. We see oscillation in the resistance [Fig. 2(d)] for the single n-p junction. This is different from the interference oscillation in Ref. 9 for the resonant cavity formed in an n-p-n structure. This can be understood from the conductance in the p-n junction regime, simplified as $G(k_F) \approx G_0 \sum_{i}^{M} \exp(-\pi k_F d \sin^2 \theta_i/2)$ for large d. With increasing gate voltage (higher k_F) we have more modes (M) in the summation with each mode transmitting with an exponentially reduced magnitude. The two opposing effects generate a sequence of peaks and valleys and dominate when we sum over few modes (either with quantization or tilt) at low temperature.

III. NEGF BASED NUMERICAL MODEL

An atomistic, numerical calculation of the junction resistance is shown in Fig. 1(d) at 80 K temperature. We use NEGF formalism for a 100 nm wide graphene sheet with d = 200 nm, close to experimental dimensions (width ~200–300 nm). A single p_z orbital basis for each carbon atom is used to compute the Hamiltonian H, while the contact self-energies $\Sigma_{1,2}$ are calculated using an iterative technique.¹⁵ The retarded Green's function is calculated as

$$G^{R} = (E_{F}I - H + V - \Sigma_{1} - \Sigma_{2})^{-1}$$
(5)

using the recursive algorithm in Ref. 16, where V is the electrostatic potential inside the device. In units of $2q^2/h$, the conductance is

$$G = \Gamma_1 G^R \Gamma_2 G^A, \tag{6}$$

where the contact broadening functions Γ are the anti-Hermitian components of Σ . For ballistic transport, *G* equals *M*, the number of modes for a uniformly gated sheet, and MT_{av} for a *p*-*n* junction. Combining these two, we calculate T_{av} and R_J from Eq. (4), which shows a jump with tilt in the *p*-*n* junction regime, very similar to the experiment.

IV. IMPACT OF CHARGED IMPURITY SCATTERING

The experimental device is on a SiO₂ substrate and the transport is diffusive with a mobility varying from 700 to 3000 cm²/V s. It is natural to inquire how the theoretical model, which so far had no scattering, corresponds to experiments. To explore this feature, we included the impact of charged impurity scattering in our model. We use a sequence of screened Gaussian potential profiles for the impurity scattering centers, ¹⁷⁻¹⁹ $U(r) = \sum_{n=1}^{N_{imp}} U_n \exp(-|r - r_n|^2/2\zeta^2)$, that specifies the strength of the impurity potential at atomic site r, with r_n being the positions of the impurity atoms and



FIG. 3. (Color online) Impact of charged impurity scattering. (a) Conductance asymmetry is diluted due to impurity potentials, and the ballistic resistance is normalized for comparison. (b) Reduced asymmetry results in a lower junction resistance for both tilted and nontilted devices, thus retaining their difference.

 ζ the screening length (≈ 8 times the C-C bond for long range scatterers). The amplitudes U_n lie in the range $[-\delta, \delta]$ (≈ 0.5 times the C-C coupling parameter) and N_{imp} is the impurity concentration ($\sim 5 \times 10^{11}$ cm⁻²). Note that the purely diffusive model discussed in Refs. 6,7, and 20 ignores the quantum mechanical spinor mismatch and WKB scaling and therefore underestimates the junction resistance for cleaner samples. Our NEGF based numerical model, on the other hand, captures both the quantum mechanical and impurity limited resistance contributions simultaneously. The junction resistance is now calculated by eliminating the contact and device resistance,¹¹

$$R_J = [R(V_{G1}, V_{G2}) + R(V_{G2}, V_{G1}) - R(V_{G1}, V_{G1}) - R(V_{G2}, V_{G2}]/2,$$
(7)

where the first two terms contain the junction resistance, while the last two do not.

Figure 3(a) shows the impact of the impurity scatterings on the total resistance and Fig. 3(b) on the junction resistance. We take the average resistance over many impurity configurations. This puts a constraint on the computation size, so we show calculations this time for a smaller device (50 nm wide). We find that both tilted and nontilted junction resistances are suppressed, thereby retaining the difference between the two. This reduction in junction resistance with scattering is quite consistent with the experiment [Fig. 1(c), the red line is for a 45° device with mobility 2270 cm²/V s, while the blue triangle is for 45° with lower mobility, 700 cm²/V s].

The reduction in the junction resistance from ballistic to diffusive transport can be understood from the trend in total resistance, shown in Fig. 3(a). Now we keep V_{G1} fixed and vary V_{G2} so that we go from an n^+ -n to n-p junction. We see a clear asymmetry in the R- V_G (Refs. 7 and 13) [the purple line normalized to the orange line in Fig. 3(a) for comparison]. The asymmetry confirms the presence of a p-n junction, which reduces the conductance due to spinor mismatch. The presence of impurity scattering reduces this asymmetry while increasing the overall resistance (the red line). The impurity potentials create a random potential variation throughout the graphene sheet on top of the applied gate voltages, thus blurring the presence of a p-n junction. Therefore the resistance due to spinor mismatch becomes less noticeable [Fig. 3(b)]. Indeed, the experimental data of the total resistance indicates an



FIG. 4. (Color online) (a) Increase in conductance in a tilted GPNJ due to edge scattering (ES) in contrast with Fig. 2(c). (b) Corresponding decrease in junction resistance due to tilt. (c) Mechanism of edge enhanced conductance for a tilted junction from an atomistic NEGF calculation. We put a small source (bright red spot)—some reflected electrons are incident at the junction again after edge reflection.

increase in asymmetry in the tilted junction,¹¹ signifying an increase in the junction resistance.

V. REVERSAL OF TILT DEPENDENCE WITH SPECULAR EDGE SCATTERING

A striking feature of the experimental results is their agreement with Eq. (3). This match is remarkable, considering that the equation was derived assuming no edge reflections and the fact that a past numerical study¹² showed in fact an *increase* in conductance with tilt. We argue that the above reversal of junction conductance with tilt is entirely due to specular edge scattering events. Indeed, from an atomistic NEGF calculation with shorter widths than lengths, we find that the transmission now shows a pronounced local maximum [Fig. 4(a), orange line], in agreement with Ref. 12, thereby increasing the junction resistance. We summarize this in Fig. 4(b), where an increasing tilt makes the resistance increase for the short channel 125 nm \times 50 nm device (a transition from the purple circle to the black diamond), but a decrease for the longer $200 \text{ nm} \times 50 \text{ nm}$ device (the orange square to the red triangle). Bearing in mind that the gate split is 100 nm, the short channel device significantly reduces edge scatterings.

To better understand the origin of such a resistance reversal, we inject electrons with a small contact at the left edge [the bright red spot in Fig. 4(c)] and plot the spatial current density under a small drain bias. The numerically computed electron trajectories show how a tilt can enhance forward scattering events at the edge and thus an increase in conductance. The enhancement arises from simple "geometrical optics" dictated by Snell's law. We can identify the incident wide angle modes $(\theta > \pi/4 - \delta)$, for which the reflected "ray" hits the upper edge with a positive x directed velocity. Such a mode will reflect back towards the junction again. The contribution from the positively directed edge scattering event is given by

$$G_{\text{edge}} = G_0 \int_{\pi/2-3\delta}^{\pi/2-\delta} \frac{T(\pi - 3\delta - \theta)}{\Delta \theta} d\theta$$

= $G_0 [2\sin^4 \delta \cos \delta] M.$ (8)

Note that only the incident angles below the critical angle are considered while setting the limits of the integration.

With the added contribution from edge scattering, the net mode-averaged transmission is given by

$$T_{\text{total}} \approx T_{\text{av}} + (1 - T_{\text{av}})T_{\text{edge}}\eta,$$
 (9)

where the *T*'s are extracted from the corresponding $G/(G_0M)$ ratios and η is a parameter that describes the efficiency of specular edge scattering. In the absence of edge scattering ($\eta = 0$), $T_{\text{total}} = T_{\text{av}}$ and decreases with tilt [Fig. 2(c)]. However, in the presence of strong edge scattering ($\eta = 1$), the added forward edge scattering term in Eq. (9) closely reproduces the NEGF result with the local transmission maximum [Fig. 4(a), black dotted line]. Comparing these results with experiments indicates that such edge scattering events are clearly minor. We conjecture that the coherent forward scattering processes captured by NEGF can be diluted down in the experiments by the presence of incoherent and non-specular scattering processes arising at the strained and rough edges of the graphene samples that tend to dephase, randomize or perhaps even trap the electrons.

VI. CONCLUSION

We have presented the theory of a tilted graphene p-njunction showing that it provides an explicit signature of chiral tunneling in graphene. The tilted device shows considerably higher junction resistance, in agreement with our recent measurements, as a result of the mismatch between angular mode distribution and the anisotropic transmission lobe. The trend in resistance gets reversed in the presence of specular edge scattering, but survives in impurity scattering. Experimental results match with the theoretical results when edge scatterings are removed, indicating their absence in the measured device. The experimental observation of chiral tunneling, particularly in the face of impurity and edge scattering, opens up the possibility of graphene's "geometric optics" based applications, e.g., lens, switches.3,4 Analogous results are expected in bilayer graphene, but not in achiral materials such as two-dimensional hexagonal boron nitride.

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